

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Antonin Rozsypal</td> <td>11/30/2006</td> </tr> <tr> <td>Roman Stuler</td> <td>11/30/2006</td> </tr> <tr> <td>Karel Ptacek</td> <td>11/30/2006</td> </tr> </tbody> </table>		Name	Execution Date	Antonin Rozsypal	11/30/2006	Roman Stuler	11/30/2006	Karel Ptacek	11/30/2006
Name	Execution Date								
Antonin Rozsypal	11/30/2006								
Roman Stuler	11/30/2006								
Karel Ptacek	11/30/2006								
<b>RECEIVING PARTY DATA</b>									
<b>Name:</b>	SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C.								
<b>Street Address:</b>	5005 E. McDowell Road								
<b>Internal Address:</b>	Intellectual Property - A700								
<b>City:</b>	Phoenix								
<b>State/Country:</b>	ARIZONA								
<b>Postal Code:</b>	85008								
<b>PROPERTY NUMBERS Total: 1</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11566891</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11566891				
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Application Number:	11566891								
<b>CORRESPONDENCE DATA</b>									
<b>Fax Number:</b>	(602)244-3169								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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<b>ATTORNEY DOCKET NUMBER:</b>	ONS00814								
<b>NAME OF SUBMITTER:</b>	Lydia McNamara								

CH \$40.00 11566891

Total Attachments: 3

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## ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

<u>Name</u>	<u>of (City/State/Country)</u>
Antonin Rozsypal	Hutisko – Solanec, Czech Republic;
Roman Stuler	Karolinka, Czech Republic;
Karel Ptacek	Roznov Pod. Radh., Czech Republic;

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

**METHOD OF FORMING A POWER SUPPLY CONTROLLER AND STRUCTURE THEREFOR** Attorney Docket No.00814

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the

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application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and

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property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Signed and Witnessed on (date): NOVEMBER 30, 2006

By (inventor signature): *Antonin Rozsypal*

**Antonin Rozsypal**

Witness by (signature):

Printed Name of Witness:

*[Signature]*

FRANTISEK SUKUP

Signed and Witnessed on (date): NOVEMBER 30, 2006

By (inventor signature): *Roman Stuler*

**Roman Stuler**

Witness by (signature):

Printed Name of Witness:

*[Signature]*

Tomáš Petrák

Signed and Witnessed on (date): NOVEMBER 30, 2006

By (inventor signature): *Karel Ptacek*

**Karel Ptacek**

Witness by (signature):

Printed Name of Witness:

*Petr Kadanka*

PETR KADANKA